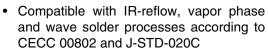


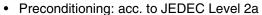
Power SMD LED in PLCC-2 Package



FEATURES

- · Available in 8 mm tape
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B





- · Automotive qualified
- · Lead (Pb)-free device
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

DESCRIPTION

The VLMK33.. series is an advanced modification of the Vishay VLMK33.. series. It is designed to incorporate larger chips, therefore, capable of withstanding a 50 mA drive current.

The package of the VLMK33.. is the PLCC-2 (equivalent to a size B tantalum capacitor).

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

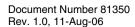
APPLICATIONS

- Interior and exterior lighting
- · Indicator and backlighting purposes for audio, video, LCDs, switches, symbols, illuminated advertising etc.
- · Illumination purpose, alternative to incandescent lamps
- Automotive qualified
- General use

PARTS TABLE				
PART	COLOR, LUMINOUS INTENSITY	ANGLE OF HALF INTENSITY (± φ)	TECHNOLOGY	
VLMK33Q2T1-GS08	Red, I _V > (90 to 355) mcd	60°	AllnGaP on GaAs	
VLMK33Q2T1-GS18	Red, I _V > (90 to 355) mcd	60°	AllnGaP on GaAs	
VLMK33R1S2-GS08	Red, $I_V = (112 \text{ to } 280) \text{ mcd}$	60°	AllnGaP on GaAs	
VLMK33R1S2-GS18	Red, $I_V = (112 \text{ to } 280) \text{ mcd}$	60°	AllnGaP on GaAs	
VLMK33S1T1-GS08	Red, $I_V = (180 \text{ to } 355) \text{ mcd}$	60°	AllnGaP on GaAs	
VLMK33S1T1-GS18	Red, I _V = (180 to 355) mcd	60°	AllnGaP on GaAs	









ABSOLUTE MAXIMUM RATINGS ¹⁾ VLMK33				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ²⁾		V _R	5	V
DC Forward current		I _F	50	mA
Power dissipation		P _V	130	mW
Junction temperature		Tj	125	°C
Operating temperature range		T _{amb}	- 40 to + 100	°C
Storage temperature range		T _{stg}	- 40 to + 100	°C
Soldering temperature	$t \le 5 s$	T _{sd}	260	°C
Thermal resistance junction/ambient	mounted on PC board (pad size > 16 mm ²)	R _{thJA}	400	K/W

Note:

- 1) T_{amb} = 25 °C unless otherwise specified
- 2) Driving LED in reverse direction is suitable for a short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS ¹⁾ , VLMK33, RED							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity	I _F = 20 mA	VLMK33Q2T1	I _V	90		355	mcd
		VLMK33R1S2	I _V	112		280	mcd
		VLMK33S1T1	I _V	180		355	mcd
Luminous flux/Luminous intensity			ϕ_V/I_V		3.14		mlm/mcd
Dominant wavelength	I _F = 20 mA		λ_{d}	611	617	624	nm
Peak wavelength	I _F = 20 mA		λ_{p}		624		nm
Spectral bandwidth at 50 % I _{rel max}	I _F = 20 mA		Δλ		18		nm
Angle of half intensity	I _F = 20 mA		φ		± 60		deg
Forward voltage	I _F = 20 mA		V _F		1.9	2.5	V
Reverse current	V _R = 5 V		V_{R}		0.01	10	μΑ

Note:

¹⁾ T_{amb} = 25 °C unless otherwise specified

LUMINOUS INTENSITY CLASSIFICATION			
GROUP	LUMINOUS INTENSITY (MCD)		
	MIN	MAX	
Q1	71	90	
Q2	90	112	
R1	112	140	
R2	140	180	
S1	180	224	
S2	224	280	
T1	280	355	
T2	355	450	

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above type Numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will be not orderable. In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel. In order to ensure availability, single wavelength groups will be not orderable.

COLOR CLASSIFICATION			
	DOMINANT WA	VELENGTH (NM)	
GROUP	RED		
	MIN	MAX	
1	611	618	
2	614	622	
3			
4			
5			
6			

Wavelength are tested at a current pulse duration of 25 ms and an accuracy of ± 1 nm

CROSSING TABLE		
VISHAY	OSRAM	
VLMK33Q2T1	LAT676-Q2T1	
VLMK33R1S2	LAT676-R1S2	
VLMK33S1T1	LAT676-S1T1	





TYPICAL CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified

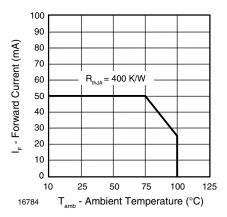


Figure 1. Forward Current vs. Ambient Temperature

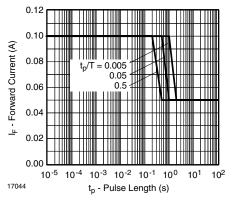


Figure 2. Forward Current vs. Pulse Length

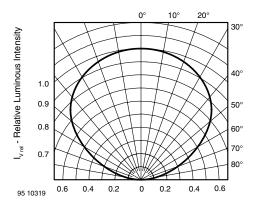


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

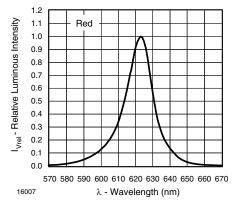


Figure 4. Rel. Luminous Intensity vs. Angular Displacement

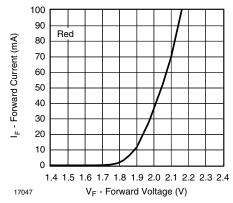


Figure 5. Forward Current vs. Forward Voltage

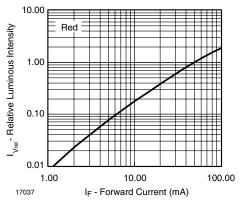


Figure 6. Change of Dominatn Wavelenght vs. Forward Current



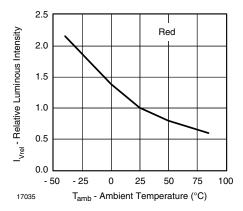


Figure 7. Relative Luminous Intensity vs. Amb. Temperature

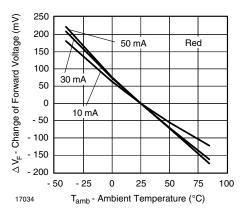


Figure 9. Change of Forward Voltage vs. Ambient Temperature

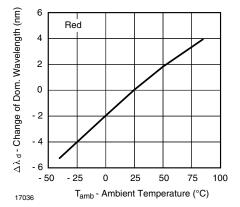
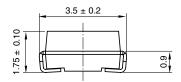


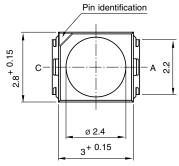
Figure 8. Change of Dominant Wavelength vs. **Ambient Temperature**

PACKAGE DIMENSIONS IN MM

95 11314-1

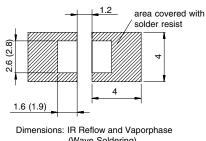






Drawing-No.: 6.541-5025.01-4 Issue: 8; 22.11.05

Mounting Pad Layout



(Wave Soldering)

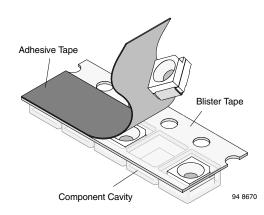




METHOD OF TAPING/POLARITY AND TAPE AND REEL

SMD LED (VLM3 - SERIES)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



TAPING OF VLM.3..

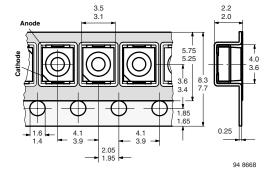


Figure 10.Tape dimensions in mm for PLCC-2

REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS08 (= 1500 PCS.)

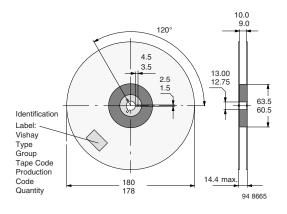


Figure 11.Reel dimensions - GS08

REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS18 (= 8000 PCS.) PREFERED

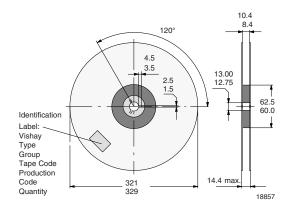


Figure 12.Reel dimensions - GS18

19885

Vishay Semiconductors

VISHAY.

SOLDERING PROFILE

Preconditioning acc. to JEDEC Level 2a 300 max. 260 °C 255 °C 250 240 °C 217 °C Temperature (°C) 200 max. 30 s 150 max. 120 s max. 100 s 100 max. Ramp Up 3 °C/s max. Ramp Down 6 °C/s 50 50 100 150 250 200 Time (s)

IR Reflow Soldering Profile for lead (Pb)-free soldering

Figure 13.Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

max. 2 cycles allowed

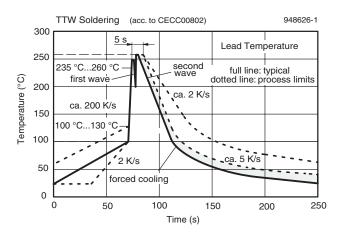
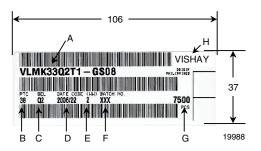


Figure 14. Double wave soldering of opto devices (all packages)

BARCODE-PRODUCT-LABEL EXAMPLE:



- A) Type of component
- B) Manufacturing Plant
- C) SEL Selection Code (Bin):e.g.: Q2 = Code for Luminous Intensity Group
- D) Date Code year/week
- E) Day Code (e.g. 2: Tuesday)
- F) Batch No.
- G) Total quantity
- H) Company Code



OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

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Vishay

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